ULTRA MINIATURE RELAY SIGNAL RELAY

FTR-C2 Series

RoHS compliant

■ FEATURES

Dimensions of large contact gap relay

Height: 11.8 mm maximum (THT)

12 mm maximum (SMT)

Length: 20.2 mm maximum Width: 10 mm maximum

Conforms to IEC60950 / EN60950 / UL1950/ CSA C22.2
 No.950 spacing & high breakdown voltage

 Recognized by UL/CSA and Bsi UL: File E63615 Vol. 2 Sec.4

CSA: Master contract 169663 Certificate 1088921

Clearance: 2.0 mm (between open contacts,

coil and contacts, contact sets)

Creepage: 2.0 mm (between open contacts,

coil and contacts, contact sets)

 HIGH RELIABILITY Bifurcated contacts

- Low power consumption 300 mV
- RoHS Compliant since production

ORDERING INFORMATION

(a)	Series Name	FTR-C2	
(b)	Termianl Apprearance	C: Through hole type G: Surface mount type	
(c)	Operation Function	A: Standard type B: Latching type	
(d)	Coil Number	Nominal Voltage	
(e)	Contact Material	G: Silver alloy	
(f)	Relay enclosing direction	B: standard enclosing direction	
(g)	Number of relays per reel	05: 500 (standard)	

Remarks: Actual marking on relay would not carry code FTR and be as below:

Ordering code Actual marking FTR-C2CA03G \rightarrow C2CA03G

*only SMT version

JAPAN 001AC

■ COIL DATA CHART

Standard type

Model	Nominal Voltage	Coil Resistance (±10%)	Must Operate Voltage	Must Release Voltage	Nominal Operating Power (±10%)
FTR-C2 () A003G	3 VDC	30.0Ω	2.25 VDC	0.3 VDC	300 mW
FTR-C2 () A005G	5 VDC	83.3Ω	3.75 VDC	0.5 VDC	300 mW
FTR-C2 () A012G	12VDC	480.0Ω	9.00 VDC	1.2 VDC	300 mW
FTR-C2 () A024G	24 VDC	1,920.0Ω	18.00 VDC	2.4 VDC	300 mW

Single coil latching type

Model	Nominal Voltage	Coil Resistance (±10%)	Set Voltage Ω	Reset Voltage	Nominal Operating Power (±10%)
FTR-C2 () B003G	3 VDC	60.0 Ω	2.25 VDC	2.25 VDC	150 mW
FTR-C2 () B005G	5 VDC	167.0 Ω	3.75 VDC	3.75 VDC	150 mW
FTR-C2 () B0012G	12VDC	960.0 Ω	9.00 VDC	9.00 VDC	150 mW
FTR-C2 () B024G	24 VDC	$3,840.0\Omega$	18.00 VDC	18.00 VDC	150 mW

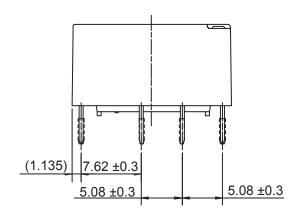
Note: All values in the table are measured at 20°C.

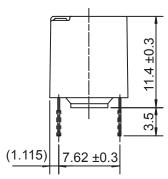
■ SPECIFICATIONS

Item			FTR-C2CA ()G FTR-C2GA-()G			
	Arrangement		2 Form C			
Contact	Material	Material		Silver alloy		
	Resistance (i	nitial)	Max. 150m ohm (at 1A 6VDC)			
	Max. Switchin	ng Power	37.5AV / 30W			
	Max. Switchin	ng Voltage	250VAC, 220 VDC			
	Max. Switchin	ng Current	1 A			
Coil	Operating Temperature		-40° C to + 85° C (no frost)			
Coil	Max. Allowa	ble Voltage	150% nominal voltage (at 20°C)			
Time a Malaca	Operate Time	Operate Time		nal voltage, without bounce		
Time Value	Release Time	e (without diode)	Max. 15ms (at nominal voltage, without bounce			
	Resistance (a	at 500 VDC)	Min. 1,000M ohm			
		Between open contacts	1,500VAC, 1 minute			
	Dieelectric Strenght	Between adjacent contacts	1,500VAC, 1 minute			
Insulation		Between coil and contacts	2,000VAC, 1 minute			
	Surge Strength	Between open contacts	2,500V (at10/700micros)			
		Between adjacent contacts	2,500V (at10/700micros)			
		Between coil and contacts	2,500V (at10/700micros)			
	Mechanical		10x10 ⁶ operations min. (at 10Hz)			
Life	Electrical (res	sistive load)	100x10³ operations min. at 1A, 30VDC, 0.5Hz 100x10³ operations min. at 0.1A, 48VDC, 0.5Hz 100x10³ operations min. at 0.3A, 125VDC, 0.5Hz			
Vibration Misopera			10 to 55 Hz at double amplitude of 3.3 mm			
Resistance	Endurance		10 to 55 Hz at double amplitude of 5 mm			
Shock	Misoperation		Min. 300 m/s ²			
Resistance	Endurance		Min. 1,000 m/s ²			
UL / CSA	Contact Rating		0.3A 125 VAC 1A 30VDC 0.3 110VDC			
IEC060950 UL1950 C22.2 No.950 EN60950	Insulation Class		Supplementary Insulation			
	Working Voltage		250 V			
	Pollution Deg	gree	2 (outside)	1 (inside)		
	Clearance		2.0 mm (outside)	2.0 mm (inside)		
	Creepage Di	stance	2.5 mm (outside)	2.0 mm (inside)		

DIMENSIONS AND SCHEMATICS

Through hole type





Unit: mm

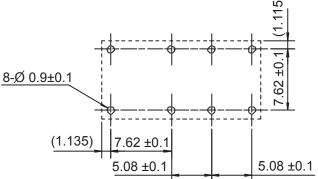
TERMINAL DESIGNATIONS

(Bottom view de-energized position)

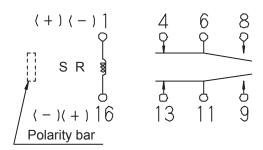


Single Coil Edition Type

(Bottom view reset position)



RECOMMENDED MOUNTING PAD

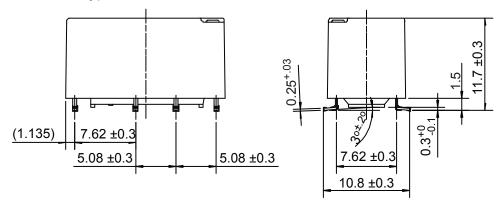


S: shows polarity of set position R: shows polarity of reset position

Unit: mm

■ DIMENSIONS AND SCHEMATICS

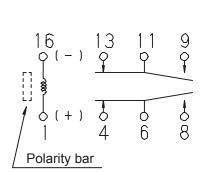
Surface mount type



Unit: mm

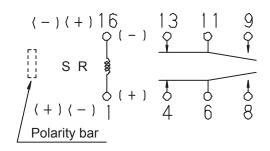
■ TERMINAL DESIGNATIONS

(Top view de-energized position)



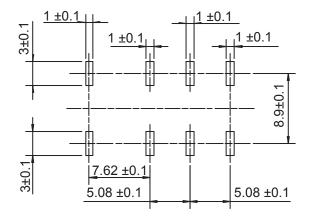
Single Coil Latching Type

(Top view reset position)



S: shows polarity of set position R: shows polarity of reset position

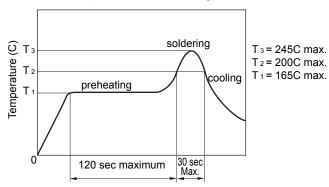
■ RECOMMENDED MOUNTING



Unit: mm

■ RECOMMENDED SOLDERING CONDITIONS (TEMPERATURE PROFILE)

IRS (Infrared Reflow Soldering)



Note:

- 1.Temperature profiles show the temperature of PC board surface.
- Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

RoHS Compliance and Lead Free Relay Information

1. General Information

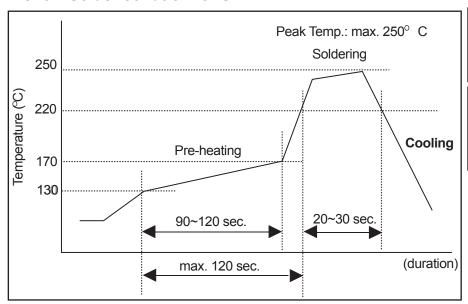
- Relays produced after the specific date code that is indicated on each data sheet are lead-free
 now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info.
 (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu.
- All signal and most power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

2. Recommended Lead Free Solder Profile

 Recommended solder paste Sn-3.0Ag-0.5Cu amd Sm-3.0 Cu-Ni (only FTR-B3 and FTR-B4 from February 2005.

Reflow Solder condtion for SMT



Flow Solder condtion:

Pre-heating: maximum 120°C dip within 5 sec. at 260°C soler bath

Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical realys.

4. Tin Whisker

 SnAgCu and SnCuNi solder is known as low risk of tin whisker. No considerable length whisker was found by our in-house test.

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